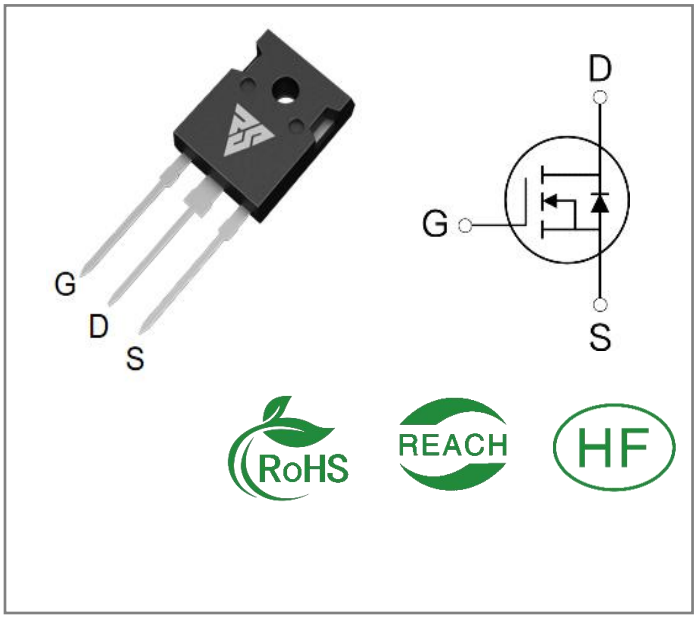
VDS	RDS(on)	ID@25℃
650V	30mΩ	55A



Applications:

- Solar Inverters
- Switch Mode Power Supplies
- High Voltage DC/DC Converters
- EV Charging
- Motor Drives

Features:

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitances
- Easy to Parallel and Simple to Drive
- Avalanche Ruggedness

Benefits:

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

Ordering Information

Part Number	Package	Marking	Packing	Qty.
RSM065030W	TO-247-3	RSM065030W	Tube	30 PCS

Maximum Ratings (TJ= 25℃ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
VDSmax	Drain - Source Voltage	650	V	VGS=0V,ID =100μA	
VGSmax	Gate - Source Voltage	-8/+22	V	Absolute maximum values	
VGSop	Gate - Source Voltage	-5/+18	V	Recommended operational values	
ID	Continuous Drain Current	55 39	A	VGS=18V, TC =25℃ VGS=18V, TC =100℃	
ID(pulse)	Pulsed Drain Current	197	A	Pulse width tp limited by TJmax	
PD	Power Dissipation	187	W	TC =25℃, TJ =175℃	
TL	Solder Temperature	260	℃		
TJ, Tstg	Operating Junction and StorageTemperature	-40 to + 175	℃		

Electrical Characteristics (TJ= 25℃ unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
V(BR)DSS	Drain-Source Breakdown Voltage	650			V	VGS=0V,ID =100μA	
VGS(th)	Gate Threshold Voltage	1.8	2.6	4.0	V	VGS= VDS, IDS=5mA,TC =25℃	
			1.8		V	VGS= VDS, IDS=5mA,TC =175℃	
IDSS	Zero Gate Voltage Drain Current		1	50	μA	VDS= 650V, VGS=0V	
IGSS	Gate-Source Leakage Current		10	250	nA	VGS=22V, VDS= 0V	
RDS(on)	Drain-Source on-state Resistance		30	50	mΩ	VGS=18V, ID =25A, TC =25℃	
			42			VGS=18V, ID =25A, TC =175℃	
Ciss	Input Capacitance		1850		pF	VGS=0V, VDS=400 V, f=1MHz，VAC=25 mV	
Coss	Output Capacitance		160				
Crss	Reverse Transfer Capacitance		15				
EON	Turn-On Switching Energy		50		μJ	VDS =400V, VGS =-5/18V,ID = 25A, RG(ext) = 2.5Ω, L= 100μH	
EOFF	Turn-Off Energy		65				
td(on)	Turn-On Delay Time		14		ns	VDS =400V, VGS =-5/18 V ID = 25A, RG(ext) =2. 5 Ω , RL =16Ω	
tr	Rise Time		15				
td(off)	Turn-Off Delay Time		28				
tf	Fall Time		8				
RG(int)	Internal Gate Resistance		3		Ω	f=1 MHz, VAC=25mV	
Qgs	Gate to Source Charge		30		nC	VDS=400V, VGS=-5/18V ID = 5A	
Qgd	Gate to Drain Charge		32		nC		
Qg	Total Gate Charge		110				

Reverse Diode Characteristics (TJ= 25℃ unless otherwise specified)

Symbol	Parameter	Typ.	Max	Unit	Test Conditions	Note
VSD	Diode Forward Voltage	4.2		V	VGS=-5V, ISD = 12.5 A, TJ = 25℃	
		3.8		V	VGS=-5V, ISD=12.5 A, TJ= 175℃	
IS	Continuous Diode Forward Current		45	A	VGS=-5V,TC= 25℃	
trr	Reverse Recovery time	25		ns	ISD= 25 A, VR = 400V	
Qrr	Reverse Recovery Charge	100		nC		
Irrm	Peak Reverse Recovery Current	5		A		

Thermal Characteristics (TJ= 25℃ unless otherwise specified)

Symbol	Parameter	Typ.	Unit	Test Conditions	Note
RθJC	Thermal Resistance from Junction to Case	0.8	℃/W		
RθJA	Thermal Resistance From Junction to Ambient	40			

Typical Feature Curve

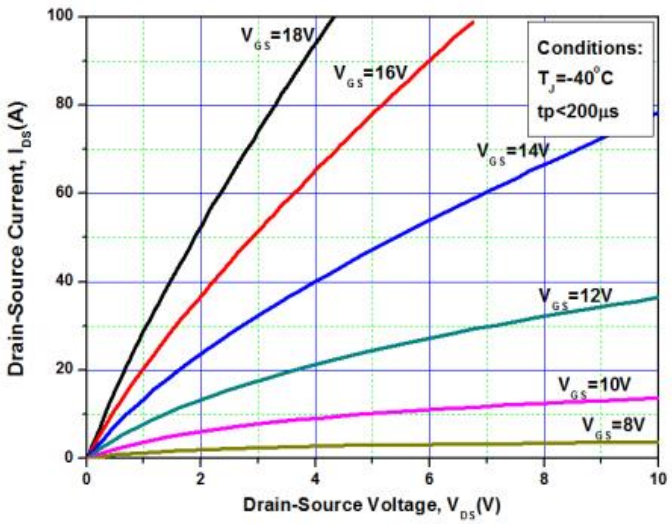


Figure 1. Output Characteristics T_J = -40℃

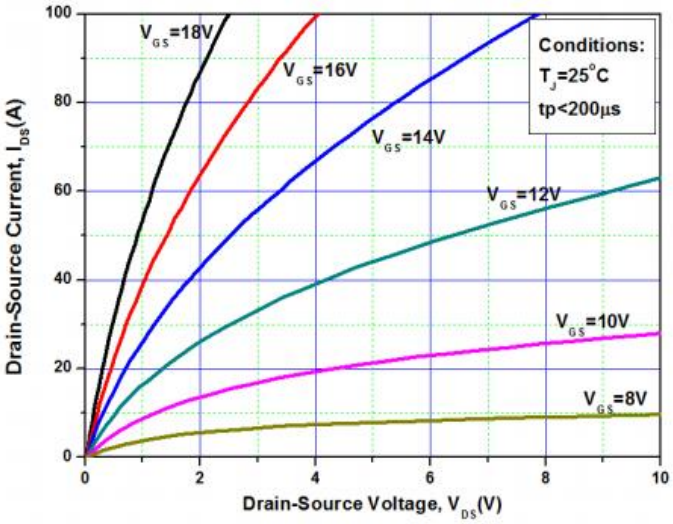


Figure 2. Output Characteristics T_J = 25℃

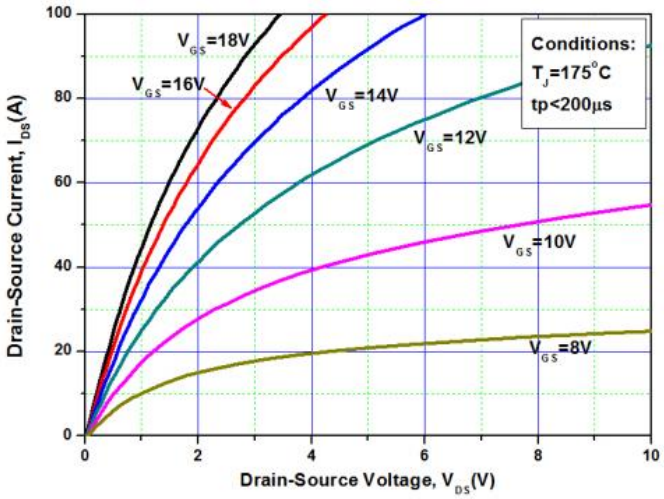


Figure 3. Output Characteristics T_J = 175℃

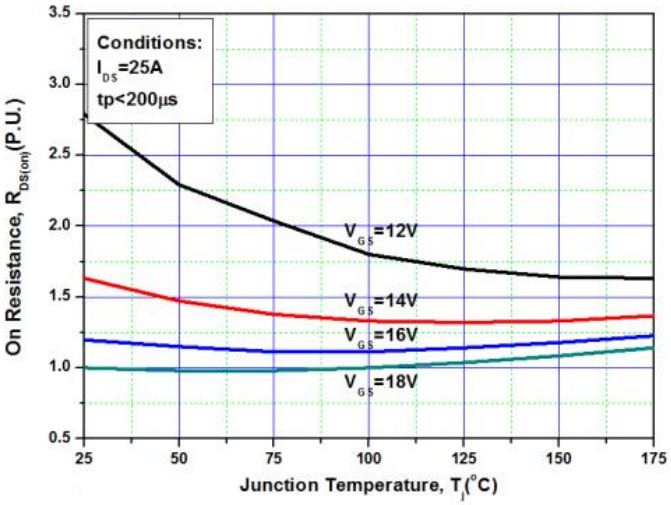


Figure 4. Normalized On-Resistance vs. Temperature

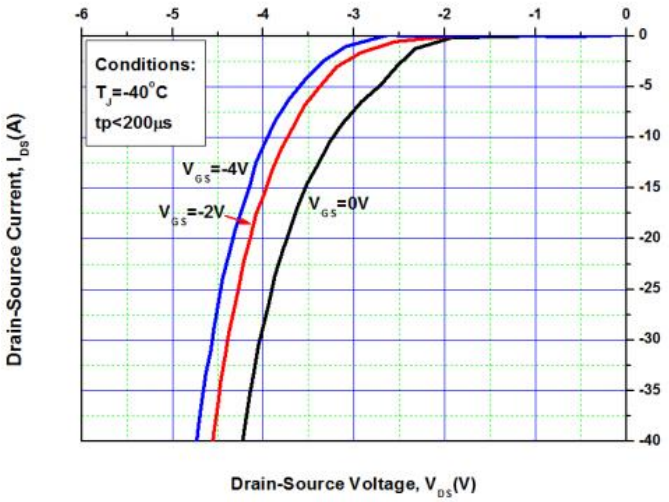


Figure 5. Body Diode Characteristic at -40℃

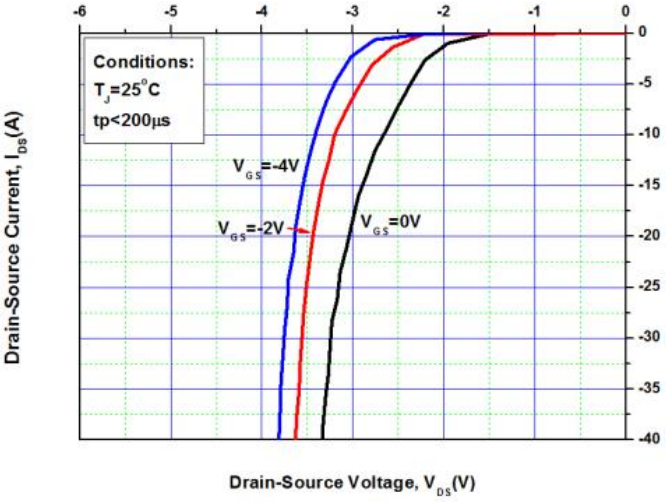


Figure 6. Body Diode Characteristic at 25℃

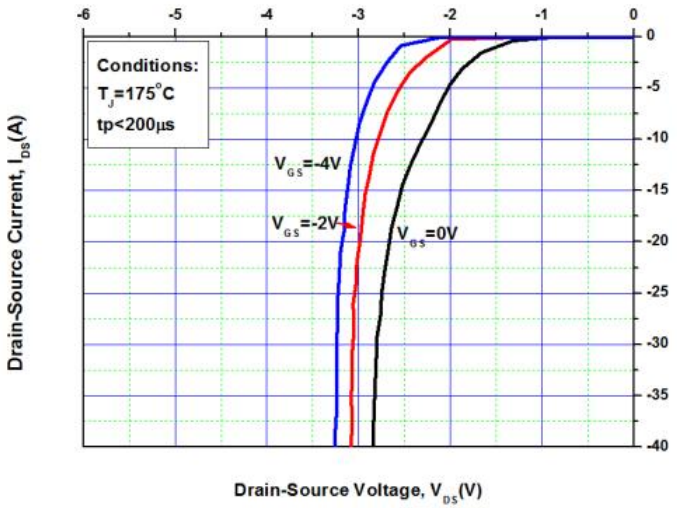


Figure 7. Body Diode Characteristic at 175℃

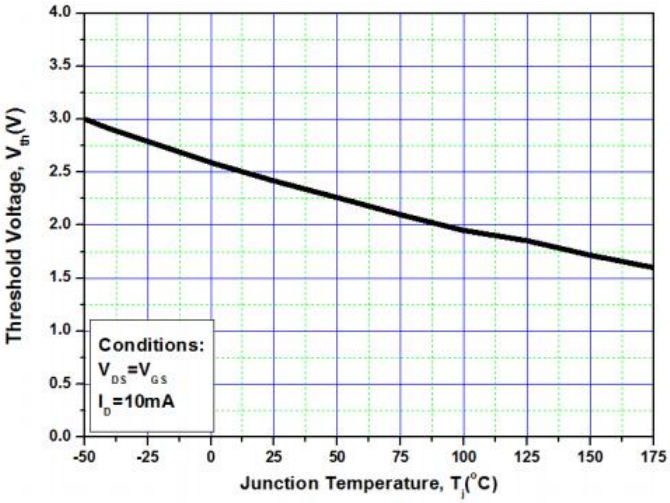


Figure 8. Threshold Voltage vs. Temperature

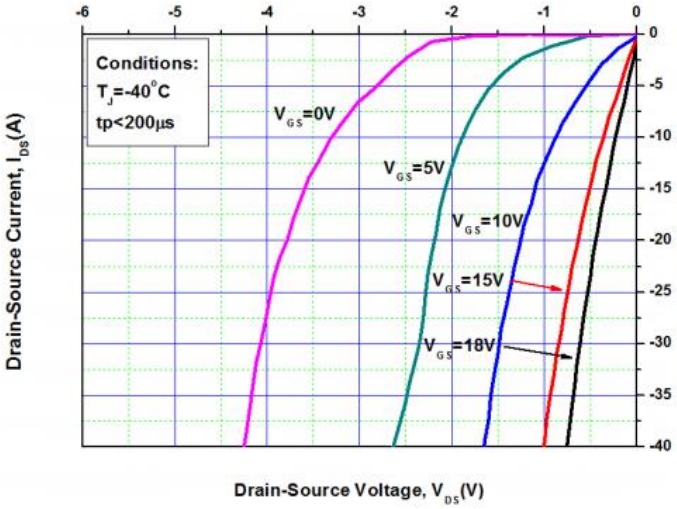


Figure 9. 3rd Quadrant Characteristic at -40℃

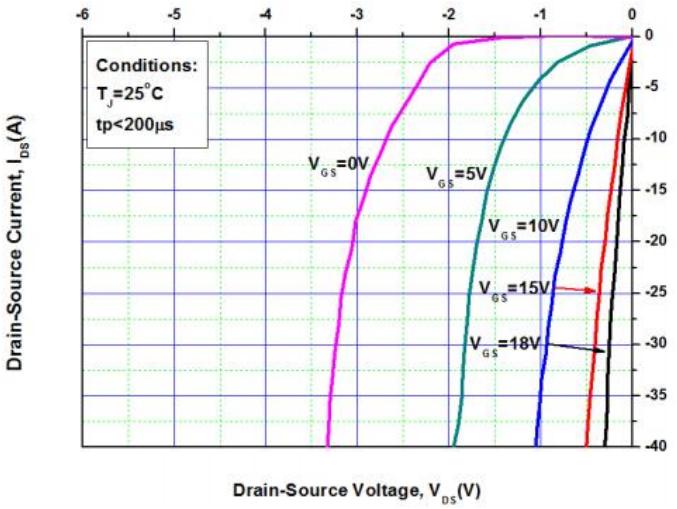


Figure 10. 3rd Quadrant Characteristic at 25℃

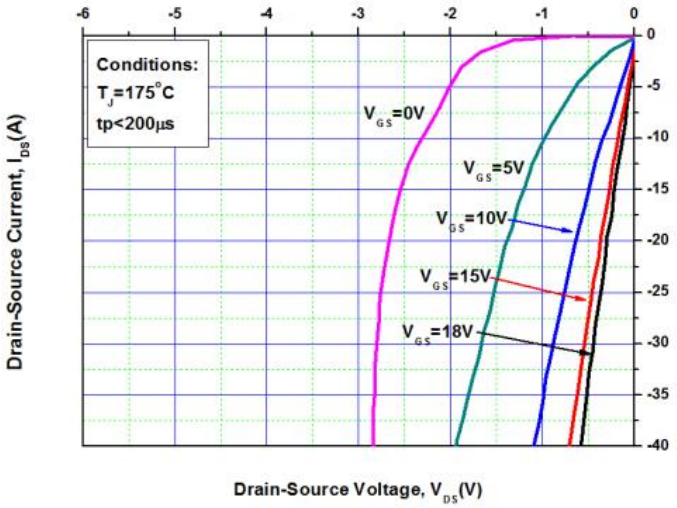


Figure 11. 3rd Quadrant Characteristic at 175℃

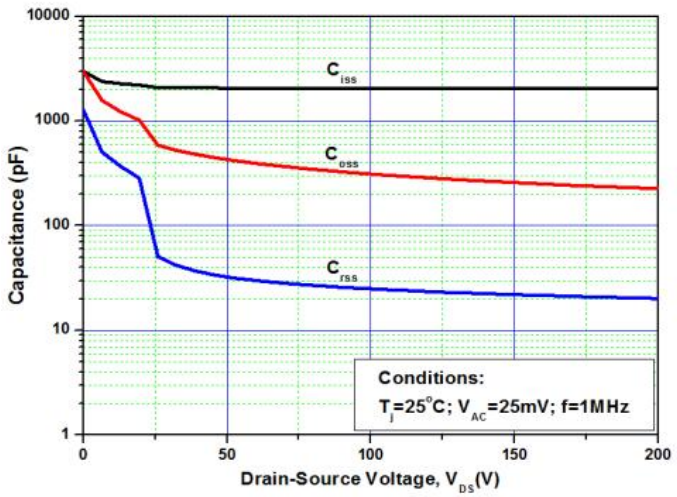


Figure 12. Capacitances vs. Drain-Source Voltage (0 - 200V)

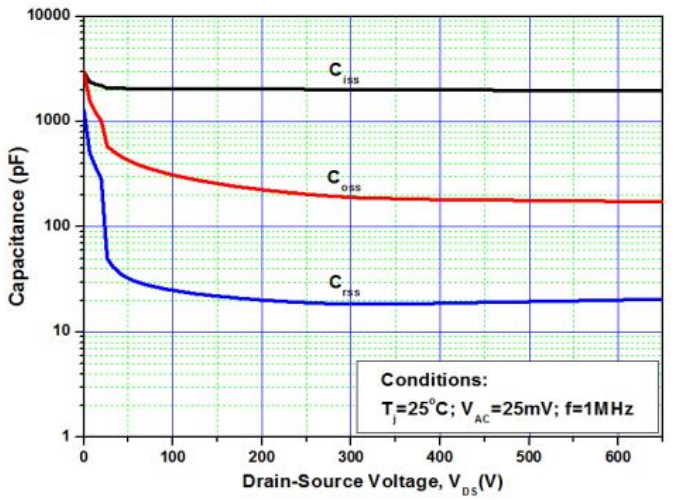
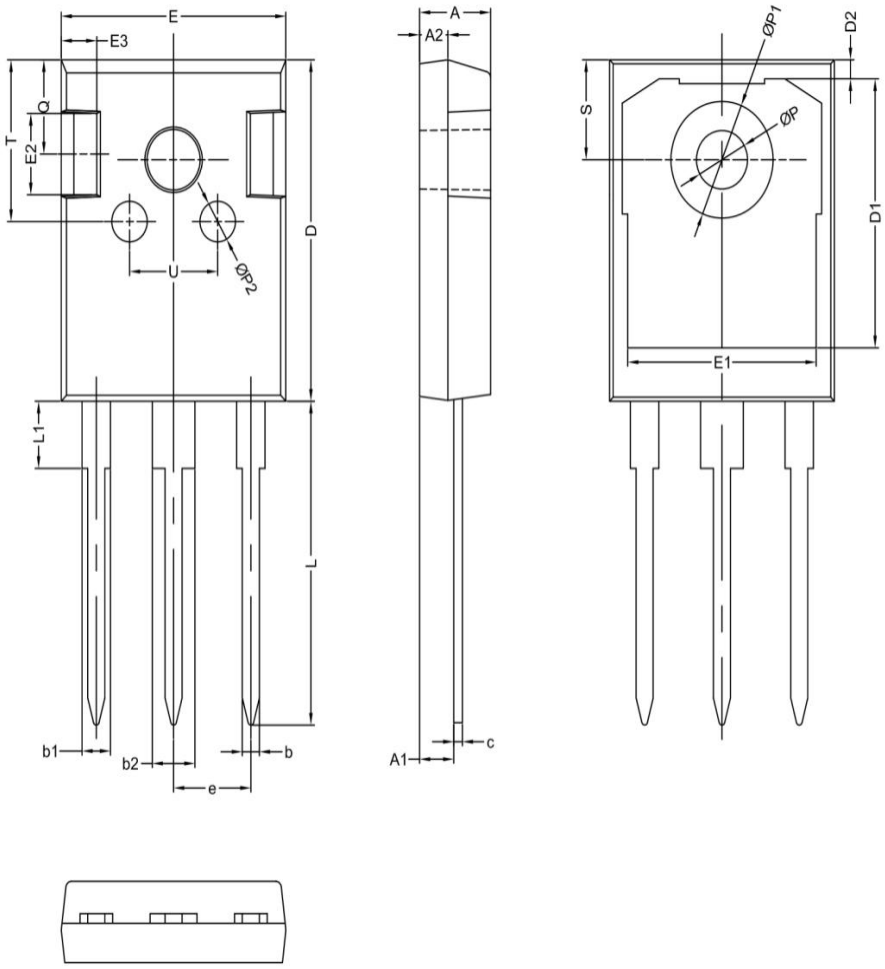


Figure 13. Capacitances vs. Drain-Source Voltage (0 - 650V)

Package outline drawing(TO-247-3 Unit: mm)



符号	机械尺寸/mm		
	最小值	典型值	最大值
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.90	2.00	2.10
b	1.10	1.20	1.35
b1		2.00	
b2		3.00	
c	0.55	0.60	0.75
D	20.80	21.00	21.20
D1		16.55	
D2		1.20	
E	15.60	15.80	16.0
E1		13.30	
E2		5.00	
E3		2.50	
e		5.44	
L	19.42	19.92	20.42
L1		4.13	
P	3.50	3.60	3.70
P1	-	-	7.40
P2		2.50	
Q		5.80	
S	6.05	6.15	6.25
T		10.00	
U		6.20	

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